

# Phase Control Thyristors (Hockey PUK Version), 650 A



TO-200AB (E-PUK)

PRODUCT SUMMARY				
Package	TO-200AB (E-PUK)			
Diode variation	Single SCR			
I <sub>T(AV)</sub>	650 A			
V <sub>DRM</sub> /V <sub>RRM</sub>	400 V to 2000 V			
V <sub>TM</sub>	2.18 V			
I <sub>GT</sub>	100 mA			
$T_J$	-40 °C to 125 °C			

### **FEATURES**

- · Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (E-PUK)



- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **TYPICAL APPLICATIONS**

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
		650	A			
$I_{T(AV)}$	T <sub>hs</sub>	55	°C			
1		1290	A			
I <sub>T(RMS)</sub>	T <sub>hs</sub>	25	°C			
1	50 Hz	8000	Δ.			
I <sub>TSM</sub>	60 Hz	8380	A A			
l <sup>2</sup> t	50 Hz	320	kA <sup>2</sup> s			
I <sup>e</sup> t	60 Hz	292	KA-S			
V <sub>DRM</sub> /V <sub>RRM</sub>		400 to 2000	V			
t <sub>q</sub>	Typical	100	μs			
T <sub>J</sub>		-40 to 125	°C			

### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V <sub>DRM</sub> /V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$\begin{split} I_{DRM}/I_{RRM} & \text{MAXIMUM AT} \\ \vdots & T_J = T_J & \text{MAXIMUM} \\ & \text{mA} \end{split}$				
	04	400	500					
VS-ST300CC 12	08	800	900					
	12	1200	1300	50				
	16	1600	1700	30				
	18	1800	1900					
	20	2000	2100					



ABSOLUTE MAXIMUM RATINGS	5					
PARAMETER	SYMBOL		VALUES	UNITS		
Maximum average on-state current	L	180° condu	ction, half sine v	vave	650 (320)	Α
at heatsink temperature	I <sub>T(AV)</sub>	double side	(single side) co	oled	55 (75)	°C
Maximum RMS on-state current	I <sub>T(RMS)</sub>	DC at 25 °C	heatsink tempe	erature double side cooled	1290	
		t = 10 ms	No voltage		8000	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		8380	A kA <sup>2</sup> s
non-repetitive surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>		6730	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	7040	
Maximum I <sup>2</sup> t for fusing		t = 10 ms	$t = 10 \text{ ms} $ No voltage reapplied $t = 8.3 \text{ ms} $ $t = 10 \text{ ms} $ $100 \% \text{ V}_{BBM}$	initial $T_J = T_J$ maximum	320	
	l <sup>2</sup> t	t = 8.3 ms			292	
		t = 10 ms			226	
		t = 8.3 ms	reapplied		207	
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 to 10	t = 0.1 to 10 ms, no voltage reapplied			kA²√s
Low level value of threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x π	$x I_{T(AV)} < I < \pi x$	$I_{T(AV)}$ ), $T_J = T_J$ maximum	0.97	V
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			V
Low level value of on-state slope resistance	r <sub>t1</sub>	(16.7 % x $\pi$ x $I_{T(AV)}$ < I < $\pi$ x $I_{T(AV)}$ ), $T_J = T_J$ maximum			0.74	mΩ
High level value of on-state slope resistance	r <sub>t2</sub>	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			0.73	11122
Maximum on-state voltage	$V_{TM}$	$I_{pk} = 1635 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$			2.18	V
Maximum holding current	I <sub>H</sub>	T 05 00	T 0500 1 10V 10 1			mA
Typical latching current	ΙL	T <sub>J</sub> = 25 °C, anode supply 12 V resistive load			1000	] "

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dI/dt	Gate drive 20 V, 20 $\Omega$ , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/μs
Typical delay time	t <sub>d</sub>	Gate current 1 A, $dl_g/dt = 1$ A/ $\mu$ s $V_d = 0.67 \% V_{DRM}$ , $T_J = 25 °C$	1.0	-10
Typical turn-off time	t <sub>q</sub>	$\begin{array}{l} I_{TM}=300~A,~T_J=T_J~maximum,~dl/dt=40~A/\mu s,\\ V_R=50~V,~dV/dt=20~V/\mu s,~gate~0~V~100~\Omega,~t_p=500~\mu s \end{array}$	100	μs

BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum critical rate of rise of off-state voltage	dV/dt	T <sub>J</sub> = T <sub>J</sub> maximum linear to 80 % rated V <sub>DRM</sub>	500	V/µs	
Maximum peak reverse and off-state leakage current	I <sub>RRM,</sub> I <sub>DRM</sub>	$T_J = T_J$ maximum, rated $V_{DRM}/V_{RRM}$ applied	50	mA	



TRIGGERING						
PARAMETER	SYMBOL	TEGT COMPLETIONS		VALUES		LINUTO
PARAMETER	STIMBUL	15	ST CONDITIONS	TYP.	MAX.	UNITS
Maximum peak gate power	$P_{GM}$	$T_J = T_J$ maximum,	t <sub>p</sub> ≤ 5 ms	10.0		w
Maximum average gate power	P <sub>G(AV)</sub>	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	VV
Maximum peak positive gate current	I <sub>GM</sub>	$T_J = T_J$ maximum,	t <sub>p</sub> ≤ 5 ms	3	.0	Α
Maximum peak positive gate voltage	+ V <sub>GM</sub>	T - T movimum	+ < 5 mg	20		V
Maximum peak negative gate voltage	- V <sub>GM</sub>	$T_J = T_J$ maximum, $t_p \le 5$ ms			.0	]
	I <sub>GT</sub>	T <sub>J</sub> = - 40 °C	Maximum required gate trigger/	200	-	
DC gate current required to trigger		T <sub>J</sub> = 25 °C		100	200	mA
		T <sub>J</sub> = 125 °C	current/voltage are the lowest		-	
		T <sub>J</sub> = - 40 °C	value which will trigger all units	2.5	-	
DC gate voltage required to trigger	$V_{GT}$	T <sub>J</sub> = 25 °C	12 V anode to cathode applied	1.8	3.0	V
	T <sub>J</sub> = 125 °C			1.1	-	
DC gate current not to trigger	I <sub>GD</sub>	T T manyimay	Maximum gate current/voltage not to trigger is the maximum	10	0.0	mA
DC gate voltage not to trigger	$V_{GD}$	$T_J = T_J$ maximum value which will not trigger any unit with rated $V_{DRM}$ anode to cathode applied		0.	25	V

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	$T_{J}$		- 40 to 125	°C	
Maximum storage temperature range	T <sub>Stg</sub>		- 40 to 150		
Maximum thermal resistance, junction to heatsink	D	DC operation single side cooled	0.09		
maximum thermal resistance, junction to neatsink	R <sub>thJ-hs</sub>	DC operation double side cooled	0.04	K/W	
Maximum thermal resistance, case to heatsink	R <sub>thC-hs</sub>	DC operation single side cooled	0.02		
Maximum thermal resistance, case to neatsink		DC operation double side cooled	0.01		
Mounting force, ± 10 %			9800 (1000)	N (kg)	
Approximate weight			83	g	
Case style		See dimensions - link at the end of datasheet	TO-200AB (I	E-PUK)	

△R <sub>thJ-hs</sub> CONDUCTION							
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION		RECTANGULAR CONDUCTION		TEST CONDITIONS	UNITS	
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS	
180°	0.010	0.011	0.007	0.007	$T_J = T_J$ maximum		
120°	0.012	0.012	0.012	0.013			
90°	0.015	0.015	0.016	0.017		K/W	
60°	0.022	0.022	0.023	0.023			
30°	0.036	0.036	0.036	0.037			

#### Note

• The table above shows the increment of thermal resistance R<sub>thJ-hs</sub> when devices operate at different conduction angles than DC

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# Vishay Semiconductors

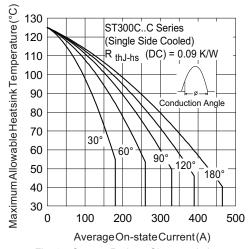


Fig. 1 - Current Ratings Characteristics

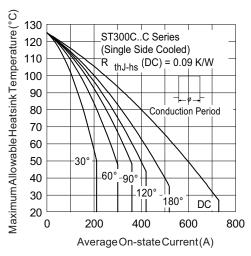


Fig. 2 - Current Ratings Characteristics

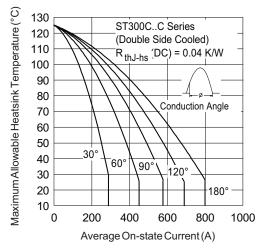


Fig. 3 - Current Ratings Characteristics

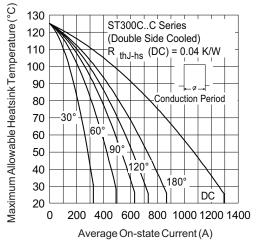


Fig. 4 - Current Ratings Characteristics

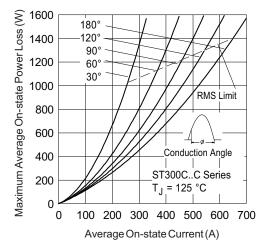


Fig. 5 - On-State Power Loss Characteristics

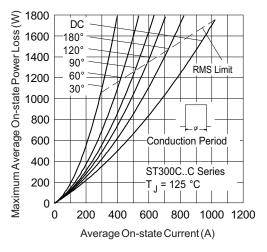


Fig. 6 - On-State Power Loss Characteristics

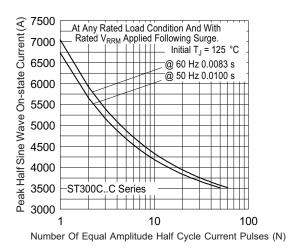


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

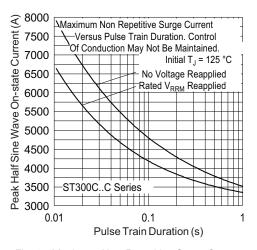


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

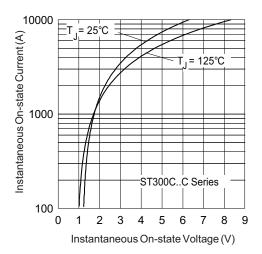


Fig. 9 - On-State Voltage Drop Characteristcs

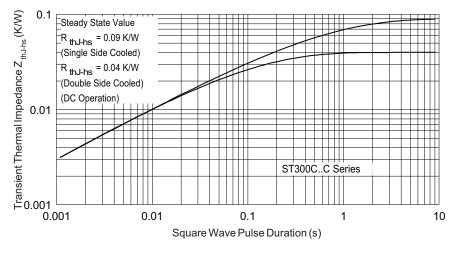


Fig. 10 - Thermal Impedance Z<sub>thJ-hs</sub> Characteristics

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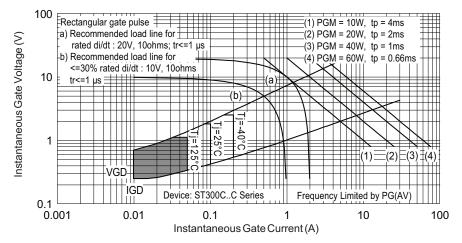
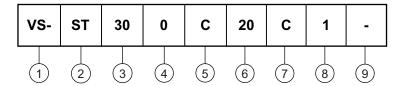


Fig. 11 - Gate Characteristics

### **ORDERING INFORMATION TABLE**

Device code



- 1 Vishay Semiconductors product
- 2 Thyristor
- 3 Essential part number
- 4 0 = Converter grade
- 5 C = Ceramic PUK
- 6 Voltage code x 100 = V<sub>RRM</sub> (see Voltage Ratings table)
- 7 C = PUK case TO-200AB (E-PUK)
- 8 0 = Eyelet terminals (gate and auxiliary cathode unsoldered leads)
  - 1 = Fast-on terminals (gate and auxiliary cathode unsoldered leads)
  - 2 = Eyelet terminals (gate and auxiliary cathode soldered leads)
  - 3 = Fast-on terminals (gate and auxiliary cathode soldered leads)
- Critical dV/dt: None = 500 V/μs (standard value)
  L = 1000 V/μs (special selection)

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95075			

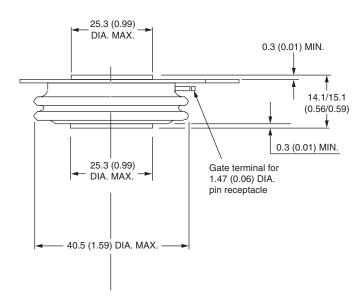


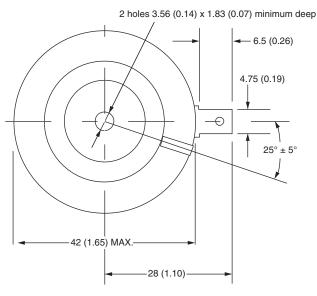
# **TO-200AB (E-PUK)**

### **DIMENSIONS** in millimeters (inches)

Anode to gate

Creepage distance: 11.18 (0.44) minimum Strike distance: 7.62 (0.30) minimum





Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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